

This

Statement of Compliance

Requested Part

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05866-1	(Pa	rt 1 of 1)
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ctive 2015/863	/EU.	
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EU REACH Regulation: (EC) No. 1907/2006

Halogen Content:

Solder Process Capability Code:

SVHC > Threshold: Pb (13% in Component Part) Article Safe Usage Statements:

Current ECHA Candidate List: JAN 2023 (233)

Candidate List Declared Against: JUL 2021 (219)

Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.

Not Low Halogen - contains Br or Cl > 900 ppm.

Wave solder capable to 265°C

Material Declarations: MD_205866-1

MD_205866-1

TE Connectivity Corporation

1050 Westlakes Drive

Berwyn, PA 19312

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change.

The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked.

Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV).

Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

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Restricted Materials Above Threshold

12 June 2023

SI)

中国电子电气产品中有害物质的名称及含量

China EEP Hazardous Substance Information

部件名称			有	「害物质		
(Component Name)	Hazardous Substance					
205866-1	铅	汞	镉	六价铬	多溴联苯	多溴二苯酸
	(Pb)	(Hg)	(Cd)	(Cr6)	(PBB)	(PBDE)
连接器系统	x	0	0	0	0	0
(Connector Systems)						
O: 表示该有害物质在ì		贡材料中的含量	均在GB/T 265	72标准规定的	限量要求以下。	
O: 表示该有害物质在ì	亥部件所有均质	贡材料中的含量	均在GB/T 265	72标准规定的	限量要求以下。	,
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O: 表示该有害物质在ì Indicates that the c	亥部件所有均质 oncentration o threshold of th	f材料中的含量 f the hazardou e GB/T 26572	均在GB/T 265 us substance ii ? standard.	572标准规定的 n all homogen	限量要求以下。 eous materials	of the part is
O: 表示该有害物质在i Indicates that the c below the relevant	亥部件所有均质 oncentration o threshold of th 少在该部件的身	5材料中的含量 of the hazardou ne GB/T 26572 其一均质材料中	均在GB/T 265 us substance in standard. 的含量超出GB	572标准规定的 n all homogen 3/T 26572标准	限量要求以下。 eous materials 规定的限量要系	of the part is 求。

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